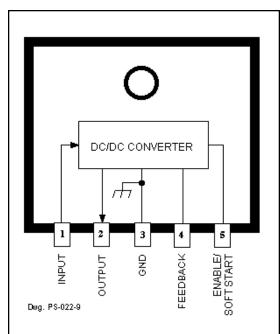
SI-8120JF

Step-Down to 12.0 V, 1.5 A, DC/DC Converter





ABSOLUTE MAXIMUM RATINGS

Input Voltage, V _I 43 V
Output Current, I _O 1.5 A*
Enable Input Voltage, V _{OE} 6 V
Junction Temperature, T_J +125°C
Storage Temperature Range, T _S 40°C to +125°C

* Output current rating is limited by input voltage, duty cycle, and ambient temperature. Under any set of conditions, do not exceed a junction temperature of +125°C.

Designed to meet high-current requirements at high efficiency in industrial and consumer applications; embedded core, memory, or logic supplies; TVs, VCRs, and office or telecommunications equipment, the SI-8120JF dc/dc step-down (buck) converter offers a constant 125 kHz switching frequency essential for low EMI noise. The npn switch is included on the die along with the oscillator, control, and logic circuitry requiring only four external components for a regulated 12.0 V output at up to 1.5 A.

A wide input voltage range and integrated thermal and overcurrent protection enhance overall system reliability. Reference accuracy and excellent temperature characteristics are provided. An output-enable input gives the designer complete control over power up, standby, or power down.

This device is supplied in a fully molded TO-220-style 5-lead flange-mounted, high power, isolated plastic package. A similar device in a lower-power surface-mount plastic package is the SI-8120JD.

FEATURES

- 14 V to 40 V Input Range
- 1.5 A Output Current at 12 V
- 2% Output Voltage Tolerance
- Foldback Current Limiting
- Constant 125 kHz Switching Frequency
- 200 µA Maximum Standby Current
- Soft Start Prevents Supply Voltage Dip
- Remote Voltage Sensing
- Thermal Protection

APPLICATIONS

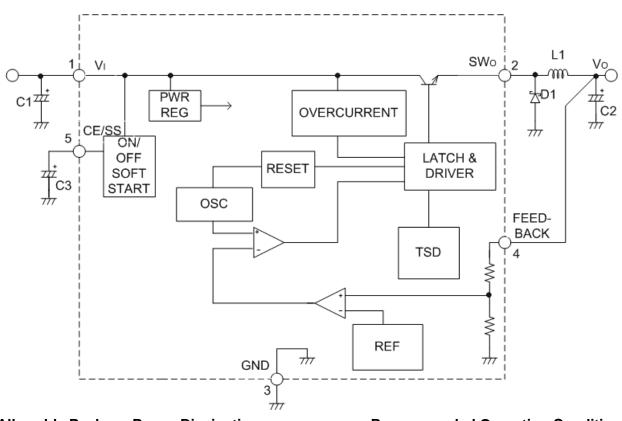
- TVs, VCRs, Electronic Games
- Embedded Core, Memory, or Logic Supplies
- Printers and Other Office Equipment
- Industrial Machinery
- Telecommunications Equipment

Always order by complete part number, e.g., |SI-8120JF|.

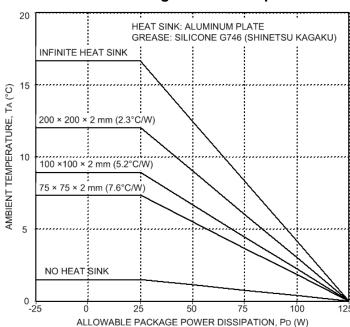




FUNCTIONAL BLOCK DIAGRAM



Allowable Package Power Dissipation



Recommended Operating Conditions

	Min	Max	Units
DC Input Voltage (I _O ≤ 1 A)	14	15	V
(I _O ≤ 1.5 A)	15	40	V
DC Output Current (V _I ≥ 6.3 V)	0	1.5	Α
Operating Junction Temp.	-30	+125	°C

This data sheet is based on Sanken data sheet SSJ-02322





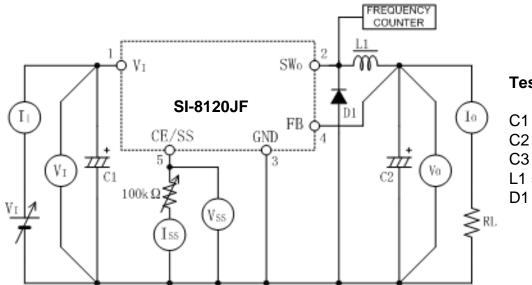
SI-8120JF Step-Down to 12.0 V, 1.5 A, DC/DC Converter

ELECTRICAL CHARACTERISTICS at $T_A = +25^{\circ}C$, $V_I = 24 \text{ V}$, $I_O = 0.5 \text{ A}$ (unless otherwise noted).

			Limits			
Characteristic	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Output Voltage	Vo		11.76	12.00	12.24	V
Ref. Volt. Temp. Coeff.	a_{vref}		_	±0.5	_	mV/°C
Output Short-Circuit Current		See note	1.6	_	_	Α
Efficiency	η		_	88	_	%
Operating Frequency	f		_	125	_	kHz
Line Regulation	$\Delta V_{O(\Delta VI)}$	$V_{I} = 18 \text{ V} \sim 30 \text{ V}, I_{O} = 0.5 \text{ A}$	_	60	130	mV
Load Regulation	$\Delta V_{O(\Delta IO)}$	$V_{I} = 24 \text{ V}, I_{O} = 0.2 \text{ A} \sim 0.8 \text{ A}$	_	10	40	mV
Quiescent Current	I _{IQ}	I _O = 0 A	_	7.0	_	mA
		$V_{CE} = 0.3 \text{ V}$		_	200	μΑ
Chip Enable Voltage	V _{CE}	Converter turn-off voltage	_	_	0.5	V
Soft-Start Current	I _{ss}	$V_{SS} = 0 V$		_	-100	μΑ

Typical values are given for circuit design information only.

Note: Output short-circuit current is at point where output voltage has decreased 5% below $V_{O(nom)}$.



Test Circuit

 $C1 = 220 \mu F/50 V$

 $C2 = 470 \mu F/25 V$

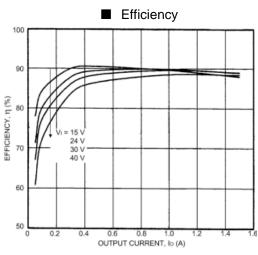
 $C3 = 0.47 \mu F/10 V$

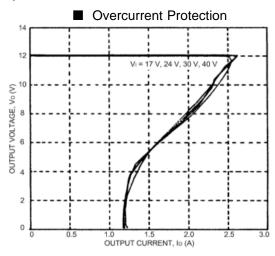
 $L1 = 100 \mu H$

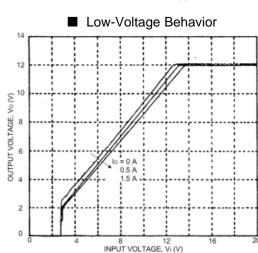
D1 = Sanken RK-16

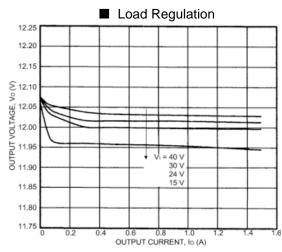
TYPICAL CHARACTERISTICS

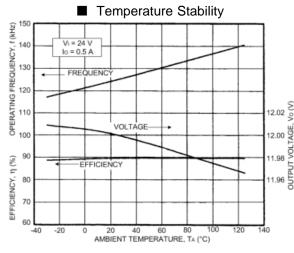
 $(T_A = 25^{\circ}C)$

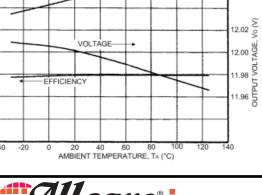














APPLICATIONS INFORMATION

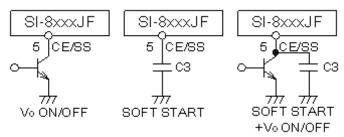
Input Capacitor (C1). Capacitors with low impedance for high-frequency ripple current must be used.

Output Capacitor (C2). Capacitors with low impedance for high-frequency ripple current must be used. Especially when the C2 impedance is high, the switching waveform may not be normal at low temperatures. Film or tantalum capacitor for C2 may cause abnormal oscillations.

Catch Diode (D1). Diode D1 must be a Schottky diode. Other diode types will result in increased forward voltage spikes, reverse current flow, increased IC power dissipation during the off period, and possible destruction of the IC.

Choke Coil (L1). If the winding resistance of the choke coil is too high, the circuit efficiency will decrease. As the overcurrent protection start current is approximately 2.5 A, attention must be paid to the heating of the coil by magnetic saturation due to overload. To reduce the output ripple, the inductor may be increased at the expense of excessive board area and cost.

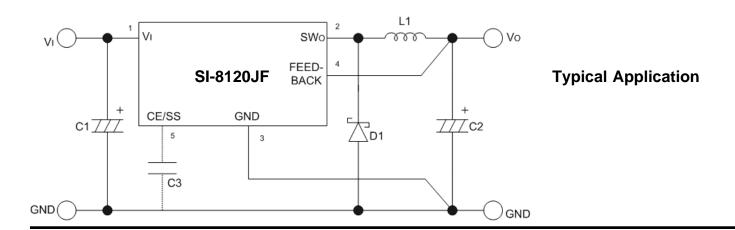
Soft-Start Capacitor (C3). Soft start for the converter is enabled by connecting a capacitor between terminal 5 and ground. The converter may be turned off by decreasing the terminal 5 voltage below 0.5 V with either an npn small-signal transistor or the output of open-collector TTL. If both a large soft-start capacitor and on/off control are desired, collector current limiting must be used to prevent transistor damage. No external voltage can be applied to terminal 5.



Parallel Operation. Parallel operation to increase load current is not permitted.

Overcurrent Protection. The SI-8000JF series has a built-in fold-back type overcurrent protection circuit, which limits the output current at a start-up mode. It thus cannot be used in applications that require current at the start-up mode such as:

- (1) constant-current load,
- (2) power supply with positive and negative outputs to common load (a center-tap type power supply), or
- (3) raising the output voltage by putting a diode or a resistor between the device ground and system ground.



APPLICATIONS INFORMATION (cont.)

Thermal Protection. Circuitry turns off the switching transistor when the junction temperature rises above 150°C. It is intended only to protect the device from failures due to excessive junction temperatures and should not imply that output short circuits or continuous overloads are permitted.

Heat Radiation and Reliability. The reliability of the IC is directly related to the junction temperature (T_J) in its operation. Accordingly, careful consideration should be given to heat dissipation. The graph on page 2 illustrates the effect of thermal resistance on the allowable package power dissipation.

When mounting to a heat sink, apply silicone grease (Shin-Etsu Chemical G746, Dow Corning Toray Silicone SC102, or Toshiba Silicone SY6260). Recommended mounting hardware torque: $0.588 \sim 0.686$ Nm or $6.0 \sim 7.0$ kgf•cm $(4.34 \sim 5.06$ lbf•ft).

The junction temperature (T_J) can be determined from either of the following equations:

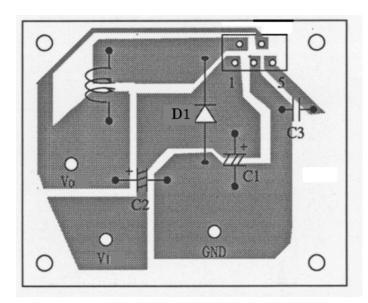
$$T_{J} = (P_{D}R_{\theta JA}) + T_{A}$$

or

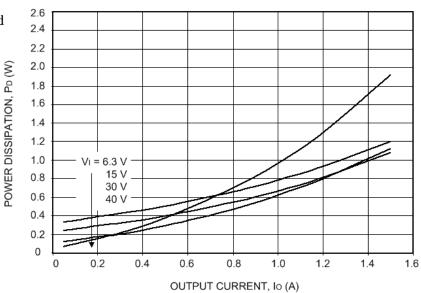
$$T_{J} = (P_{D}R_{\theta JC}) + T_{C}$$

where $P_D = V_I I_I - V_O I_O - V_F I_O (1 - [V_O/V_I])$ or the adjacent graph,

 V_F = the Schottky diode forward voltage, and $R_{\theta IC} = 6^{\circ}\text{C/W}$.

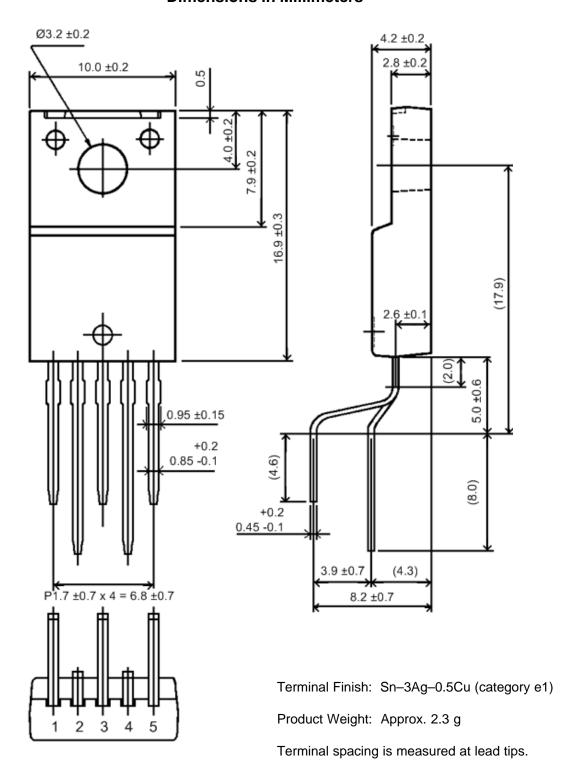


Layout Guideline

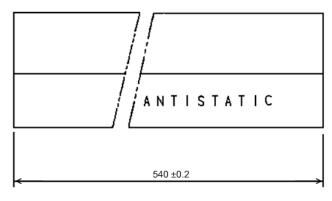


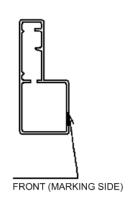


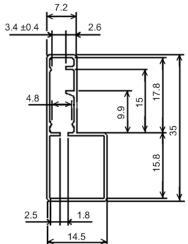
Dimensions in Millimeters



Shipping Container Dimensions in Millimeters



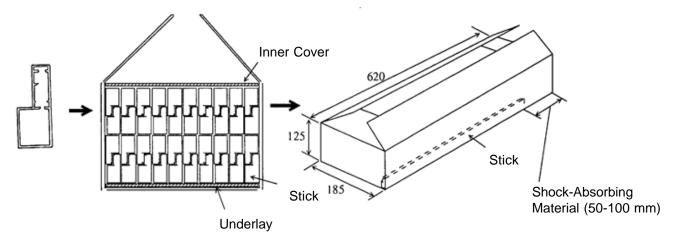




Primary Packing: 50 pieces per stick

Product Thickness: 0.7 mm ±0.3 mm Material: Hard polyvinylchloride (transparent) Warp: Within 2 mm against L-shape dimension

Secondary Packing: Ten sticks, four layers (2000 pieces per box). Cardboard box.





Switching Regulators

SI-8120JF Step-Down to 12.0 V, 1.5 A, DC/DC Converter

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